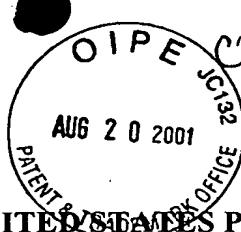
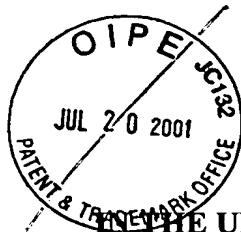


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THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: **Toshiya SATOH et al.**

Application No.: **Not Yet Assigned**

Filing Date: **March 16, 2001**

Title: **SEMICONDUCTOR DEVICE AND MANUFACTURING  
METHOD THEREOF**

Art Unit: **Not Yet Assigned**

Examiner: **Not Yet Assigned**

**PRELIMINARY AMENDMENT**

Assistant Commissioner of Patents  
Washington, D.C. 20231

RECEIVED  
AUG 23 2001  
1C 2800 MAIL ROOM  
August 20, 2001

Sir:

Prior to examination, please enter thereto the following Preliminary Amendment.

**IN THE SPECIFICATION:**

Please amend the specification as follows:

**Page 19, starting at line 11, insert -Fig. 38 is a view showing a semiconductor**

device according to first, third, forth, sixth, seventh and ninth embodiments of this invention  
and illustrates the structure of its substantial part.

A1

Fig. 39 is a view showing a semiconductor device according to second, fifth and  
eighth embodiments of this invention and illustrates the structure of its substantial part.;

Fig. 40 is a view showing a semiconductor device according to tenth, fourteenth,  
sixteenth, seventeenth, eighteenth, twenty-second, twenty-sixth, twenty-eighth, twenty-ninth,  
thirtieth, thirty-second and thirty-third embodiments of this invention and illustrates the